Unit: mm

TOSHIBA Field Effect Transistor Silicon P Channel MOS Type (High Speed U-MOSII)

# TPC8104-H

High Speed and High Efficiency DC-DC Converters Lithium Ion Battery Applications Notebook PCs

Portable Equipment Applications

• Small footprint due to small and thin package

• High speed switching

• Small gate charge : Qg = 17 nC (typ.)

• Low drain-source ON resistance :  $RDS(ON) = 38 \text{ m}\Omega \text{ (typ.)}$ 

• High forward transfer admittance :  $|Y_{fs}| = 7.0 \text{ S (typ.)}$ 

• Low leakage current :  $I_{DSS} = -10 \mu A \text{ (max) (V}_{DS} = -30 \text{ V)}$ 

• Enhancement-mode :  $V_{th} = -0.8 \sim -2.0 \text{ V (V}_{DS} = -10 \text{ V, I}_{D} = -1 \text{ mA)}$ 

#### Maximum Ratings (Ta = 25°C)

Characte	ristics	Symbol	Rating	Unit
Drain-source voltage		$V_{DSS}$	-30	V
Drain-gate voltage (R	$k_{GS} = 20 \text{ k}\Omega$	$V_{DGR}$	-30	V
Gate-source voltage		V <sub>GSS</sub>	±20	V
Drain current	DC (Note 1)	I <sub>D</sub>	-5	Α
Diam current	Pulse (Note 1)	$I_{DP}$	-20	
Drain power dissipation	on (t = 10 s) (Note 2a)	$P_{D}$	2.4	W
Drain power dissipation	on (t = 10 s) (Note 2b)	P <sub>D</sub>	1.0	W
Single pulse avalanch	ne energy (Note 3)	E <sub>AS</sub>	32.5	mJ
Avalanche current		I <sub>AR</sub>	-5	Α
Repetitive avalanche	energy Note 2a) (Note 4)	E <sub>AR</sub>	0.24	mJ
Channel temperature		T <sub>ch</sub>	150	°C
Storage temperature	range	T <sub>stg</sub>	−55 to 150	°C

Note: For (Note 1), (Note 2), (Note 3) and (Note 4), please refer to the next page.

This transistor is an electrostatic sensitive device. Please handle with caution.

0.595TYP 1.27

5.5MAX

5.0±0.2

1, 2, 3 SOURCE
4 GATE
5, 6, 7, 8 DRAIN

JEDEC

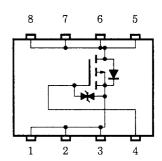
JEITA

TOSHIBA

2-6J1B

Weight: 0.080 g (typ.)

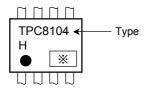
### **Circuit Configuration**



#### **Thermal Characteristics**

Characteristics	Symbol	Max	Unit
Thermal resistance, channel to ambient (t = 10 s) (Note 2a)	R <sub>th (ch-a)</sub>	52.1	°C/W
Thermal resistance, channel to ambient (t = 10 s) (Note 2b)	R <sub>th (ch-a)</sub>	125	°C/W

### Marking (Note 5)

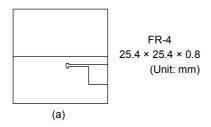


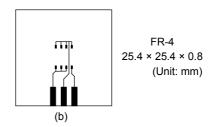
Note 1: Please use devices on condition that the channel temperature is below 150°C.

Note 2:

(a) Device mounted on a glass-epoxy board (a)

(b) Device mounted on a glass-epoxy board (b)





Note 3:  $V_{DD}$  = -24 V,  $T_{ch}$  = 25°C (initial), L = 1.0 mH,  $R_G$  = 25  $\Omega$ ,  $I_{AR}$  = -5 A

Note 4: Reptitve rating; pulse width limited by maximum channel temperature.

Note 5: ● on lower left of the marking indicates Pin 1.

\* shows Lot number. (year of manufacture: last decimal digit of the year of manufacture, month of manufacture: january to december are denoted by letters A to L respectively)

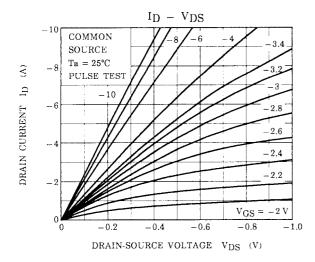
# Electrical Characteristics (Ta = 25°C)

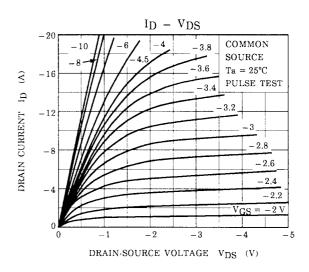
Charac	eteristics	Symbol	Test Condition	Min	Тур.	Max	Unit	
Gate leakage cu	ırrent	I <sub>GSS</sub>	V <sub>GS</sub> = ±16 V, V <sub>DS</sub> = 0 V	_	_	±10	μΑ	
Drain cut-off cu	rrent	I <sub>DSS</sub>	V <sub>DS</sub> = -30 V, V <sub>GS</sub> = 0 V	_	_	-10	μA	
Drain-source breakdown voltage		V <sub>(BR)DSS</sub>	$I_D = -10 \text{ mA}, V_{GS} = 0 \text{ V}$	-30	_	_	V	
		V <sub>(BR)DSX</sub>	$I_D = -10 \text{ mA}, V_{GS} = 20 \text{ V}$	-15	_	_	v	
Gate threshold v	oltage/	$V_{th}$	$V_{DS} = -10 \text{ V}, I_D = -1 \text{ mA}$	-0.8	_	-2.0	V	
Drain-source ON resistance		R <sub>DS</sub> (ON)	V <sub>GS</sub> = -4 V, I <sub>D</sub> = -2.5 A	_	68	120	- mΩ	
		R <sub>DS</sub> (ON)	$V_{GS} = -10 \text{ V}, I_D = -2.5 \text{ A}$	_	38	65		
Forward transfer	r admittance	Y <sub>fs</sub>	V <sub>DS</sub> = -10 V, I <sub>D</sub> = -2.5 A	3.5	7.0	_	S	
Input capacitano	e	C <sub>iss</sub>		_	730	_		
Reverse transfer capacitance		C <sub>rss</sub>	$V_{DS} = -10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$	_	190	_	pF	
Output capacitance		C <sub>oss</sub>		_	270	_		
Switching time	Rise time	t <sub>r</sub>	$V_{GS}$ $V_{OUT}$ $V_{OUT}$ $V_{DD} = -15 V$	_	8	_		
	Turn-on time	t <sub>on</sub>		_	15	_		
	Fall time	t <sub>f</sub>		_	26	_	ns	
	Turn-off time	t <sub>off</sub>	$V_{ m IN}: t_{ m r}, t_{ m f} < 5   m ns, \ Duty \leq 1\%, t_{ m W} = 10  \mu  m s$	_	76	-		
Total gate charge (Gate-source plus gate-drain)		Qg			17	_		
Gate-source charge		Q <sub>gs</sub>	$V_{DD} \approx -24 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$		13	_	nC	
Gate-drain ("miller") charge		$Q_{gd}$		_	4	_		

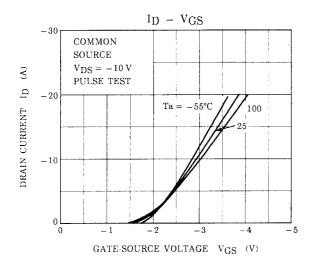
## Source-Drain Ratings and Characteristics (Ta = 25°C)

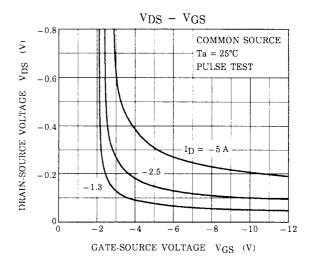
Charact	eristics	Symbol	Test Condition	Min	Тур.	Max	Unit
Drain reverse current	Pulse (Note 1)	I <sub>DRP</sub>	_	ı	ı	-2.0	Α
Forward voltage (	(diode)	$V_{DSF}$	$I_{DR} = -5 A$ , $V_{GS} = 0 V$	-	_	1.2	V

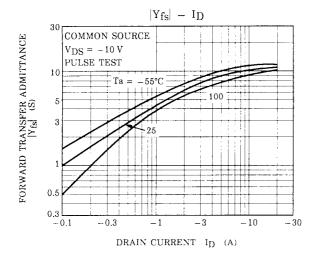
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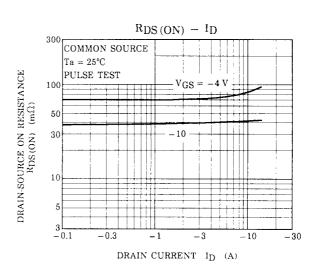




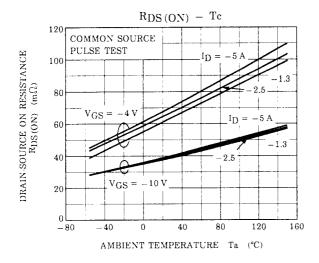


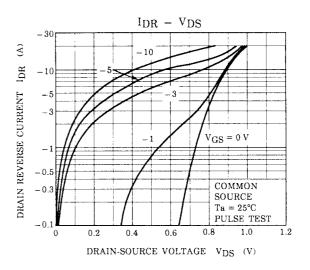


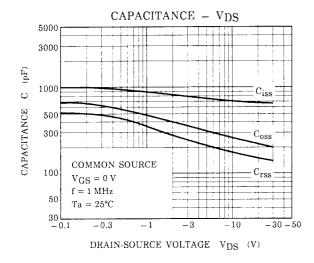


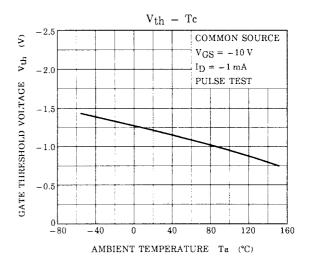


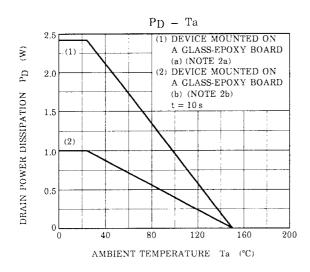
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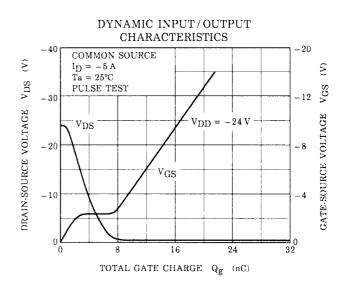




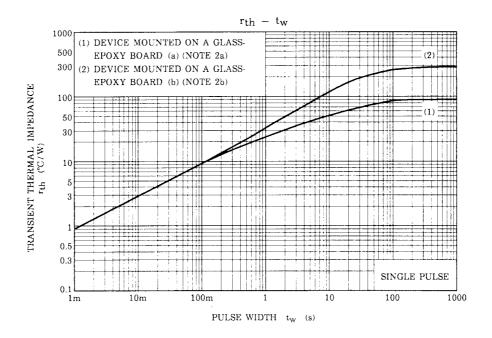


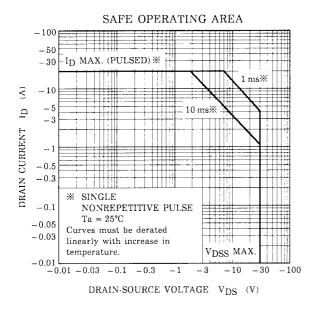


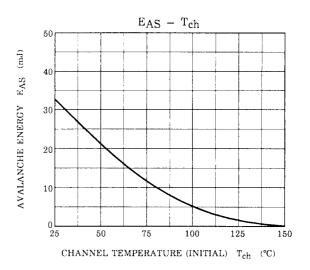


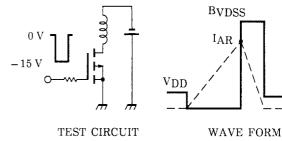


5









$$\begin{array}{l} T_{ch}\!=\!25^{\circ}\!C\:(Initial) \\ Peak\:\:I_{AR}=-5\:A,\:R_{G}=25\:\Omega \end{array}\:\:E_{AS}=\frac{1}{2}\cdot L\:\cdot I^{2}\cdot\:(\frac{B_{VDSS}}{B_{VDSS}-V_{DD}}\:)\:\:V_{DD}=-24\:V,\:L=1.0\:mH \end{array}$$

VDS

6 2002-09-11

#### RESTRICTIONS ON PRODUCT USE

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